



AdvantisV™ leverages high-end base technologies and easily integrated premium options to deliver cost-effective, value-driven productivity in low-margin environments. This versatility, coupled with a robust architecture with minimal maintenance requirements, provides investment protection and a low cost of ownership. AdvantisV incorporates a highly accurate architecture and closed-loop controls for superior yields. It also generates exceptional and consistent output across a range of environments from NPI to volume production. AdvantisV has all the functionality to meet today's challenges, with a growth path for tomorrow's.

- ✓ 1 and 2-beam variants utilizing flagship Fuzion base architecture
- ✓ Throughput up to 66,500 cph per module
- ✓ Complementary high-speed and multifunction models
- ✓ Minimal entry price and initial investment
- ✓ Simplified base configurations, easily integrated options
- ✓ Premium options, including advanced NPI toolbox
- ✓ Broadest component range and board size capabilities
- ✓ Class-leading performance and technologies for long usable life
- ✓ Low cost of ownership with minimal maintenance requirements

ADVANTISV MODELS & SPECIFICATIONS

- **AdvantisV1-07** - A versatile IC placement platform, perfect for special processes such as pin-in-paste and OFA
- **AdvantisV1-30** - Superb for high-mix NPI environments and large board applications. Also a high-volume line booster solution.
- **AdvantisV2-60** - Flexible, high-speed productivity for medium-volume environments. Also a powerful line booster solution or high-performance small part placer.

Model	Max Throughput (cph)	Accuracy ($\mu\text{m}@>1.00$ Cpk)	Max Board Size	Max Feeder Inputs (8mm)	Component Range
AdvantisV1-07	16,500	± 38 (Chips) / ± 27 (ICs)	508 x 813mm	128 (1 ULC)	0201 - 150mm sq, 40mm tall
AdvantisV1-30	35,000	± 34 (Chips) / ± 34 (ICs)	508 x 1016mm	136	01005 - 30mm sq
AdvantisV2-60	66,500	± 34 (Chips) / ± 34 (ICs)	508 x 1300mm	136	01005 - 30mm sq

